

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of :
: Kikuchi et al. :
: Group Art Unit: Unassigned
Application S/N: New Application :
: Examiner: Unassigned
Filed: Concurrently herewith :
:
For: PARTIAL DISCHARGING-RESISTANT WIRE ENAMEL COMPOSITION AND
PARTIAL DISCHARGING-RESISTANT MAGNET WIRE

PRELIMINARY AMENDMENT

Honorable Assistant
Commissioner
for Patents
Washington, DC 20231

Sir:

This preliminary amendment is directed to the above-referenced application. Prior to examination, please amend the application as follows:

IN THE SPECIFICATION

Please amend the specification as follows:

Page 10, lines 19-24

Silica sol (dispersing medium; dimethylacetamide, average particle size of silica: 30nm) was added to a polyamideimide wire enamel composition, and mixed by stirring to obtain a partial discharge-resistant wire enamel composition containing 40 parts by weight of the silica fine particle per 100 parts by weight of wire enamel resin.

REMARKS

This preliminary amendment is directed to the above-referenced new application.

Claims 1-5 are pending. The specification has been amended to correct a minor editorial defect. No new matter is added.

In view of the foregoing, it is respectfully submitted that the application is in condition for allowance and an early indication of the same is courteously solicited. The Examiner is respectfully requested to contact the undersigned by telephone at the below listed local telephone number, in order to expedite resolution of any remaining issues and further to expedite passage of the application to issue, if any further comments, questions or suggestions arise in connection with the application.

Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 12-0429 and please credit any excess fees to such deposit account.

Respectfully submitted,
LALOS & KEEGAN



Alfred A. Stadnicki
Registration No. 30,226 ✓

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Date: February 15, 2001

**APPENDIX TO NEW UTILITY APPLICATION FILED CONCURRENTLY HEREWITH
SHOWING CHANGES TO SPECIFICATION WITH ADDITIONS UNDERLINED AND
DELETIONS BRACKETED**

Silica sol (dispersing medium; dimethylacetamide, average particle size of silica: 30nm) was added to a [polyimide] polyamideimide wire enamel composition, and mixed by stirring to obtain a partial discharge-resistant wire enamel composition containing 40 parts by weight of the silica fine particle per 100 parts by weight of wire enamel resin.